Am2148/Am2149 Am21L48/Am21L49

1024x4 Static RAM



DISTINCTIVE CHARACTERISTICS

- · High speed access times as fast as 35 ns
- · Fully static storage and interface circuitry
- Automatic power-down when deselected (Am2148)
- TTL-compatible interface levels

- Low power dissipation
 - Am2148: 990 mW active, 165 mW power down
 - Am21L48: 688 mW active, 110 mW power down
- High output drive
 - Up to seven standard TTL loads

GENERAL DESCRIPTION

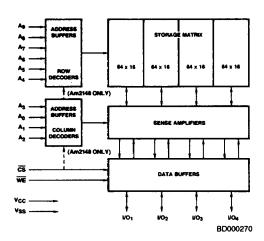
The Am2148 and Am2149 are high-performance, static, N-Channel, read/write, random-access memories, organized as 1024 x 4. Operation is from a single 5-V supply, and all input/output levels are identical to standard TTL specifications. The Am2148 and Am2149 are the same except that the Am2148 offers an automatic CS power-down feature.

The Am2148 remains in a low-power standby mode as long as \overline{CS} remains HIGH, thus reducing its power requirements.

The Am2148 power decreases from 990 mW to 165 mW in the standby mode. The CS input does not affect the power dissipation of the Am2149.

Data readout is not destructive and has the same polarity as data input. $\overline{\text{CS}}$ provides for easy selection of an individual package when the outputs are OR-tied.

BLOCK DIAGRAM

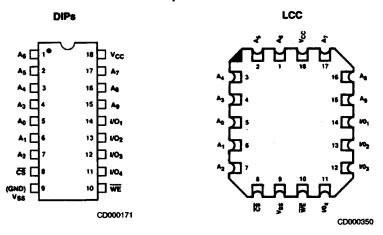


PRODUCT SELECTOR GUIDE

Part Number Maximum Access Time (ns)		Am2148/9 -35	Am2148/9 -45	Am21L48/9 -45	Am2148/9 -55	Am21L48/9 -55	Am2148/9 -70	Am21L48/9 -70	
		35	45	45	55	55	70	70	
ICC Max. (mA) 0 1		180	180	125	180	125	180	125	
I _{SB} * Max. (mA)	+ 70°C	30	30	20	30	20	30	20	
ICC Max. (mA) -55 to		N/A	180	N/A	180	N/A	180	N/A	
I _{SB} * Max. (mA)	+ 125°C	N/A	30	N/A	30	N/A	30	N/A	

^{*}Am2148 and Am21L48 only.

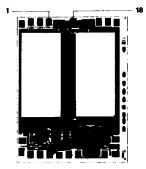
CONNECTION DIAGRAMS Top View



Note: Pin 1 is marked for orientation.

METALLIZATION AND PAD LAYOUT

Address Designators						
External	Internal					
Ao	A7					
A ₁	A ₈					
A ₂	A ₉					
A3	A6					
A ₄	A ₅					
A ₅	A4					
A ₆	A3					
A ₇	A ₂					
A ₈	A ₁					
Ag	A ₀					



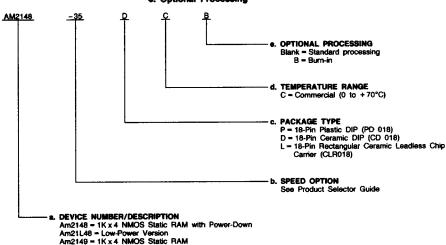
Die Size: 0.107" x 0.145"

ORDERING INFORMATION

Standard Products

AMD standard products are available in several packages and operating ranges. The order number (Valid Combination) is formed by a combination of: a. Device Number

- b. Speed Option (if applicable)
- c. Package Type d. Temperature Range
- e. Optional Processing



Valid	Combinations
AM2148-35	
AM2149-35	
AM21L48-45	
AM21L49-45	PC, PCB, DC, DCB.
AM21L48-55	ic, ics
AM21L49-55	
AM21L48-70	
AM21L49-70	
AM2148-45	
AM2149-45	
AM2148-55	PC, PCB, DC, DCB.
AM2149-55	LC, LCB
AM2148-70	
AM2149-70	

Am21L49 = Low-Power Version

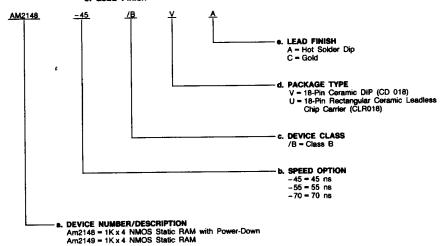
Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations, to check on newly released valid combinations, and to obtain additional data on AMD's standard military grade products.

MILITARY ORDERING INFORMATION APL Products

AMD products for Aerospace and Defense applications are available in several packages and operating ranges. APL (Approved Products List) products are fully compliant with MIL-STD-883C requirements. The order number (Valid Combination) is formed by a combination of: a. Device Number

- b. Speed Option (if applicable)
- c. Device Class
- d. Package Type
- e. Lead Finish



Valid Combinations						
AM2148-45						
AM2149-45						
AM2148-55	/BVA					
AM2149-55	7844					
AM2148-70 AM2149-70						
AM2148-45						
AM2149-45						
AM2148-55	/BUC					
AM2149-55	7800					
AM2148-70						
AM2149-70						

Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations or to check for newly released valid combinations.

Group A Tests

Group A Tests consist of Subgroups 1, 2, 3, 7, 8, 9, 10, 11.

PIN DESCRIPTION

A₀ - A₉ Address inputs

The address input lines select the RAM location to be read or written.

CS Chip Select (Input, Active LOW)

The Chip Select selects the memory device.

WE Write Enable (input, Active LOW)

When \overline{WE} is LOW and \overline{CS} is also LOW, data is written into the location specified on the address pins.

i/O₁-I/O₄ Data in/Out Bus (Bidirectional, Active HIGH)

These I/O lines provide the path for data to be read from or written to the selected memory location.

V_{CC} Power Supply

V_{SS} Ground

ABSOLUTE MAXIMUM RATINGS

Storage Temperature	65 to +150°C
Ambient Temperature with	
Power Applied	55 to +125°C
Supply Voltage	0.5 V to +7.0 V
Signal Voltages with	
Respect to Ground	3.5 V to +7.0 V
Power Dissipation	1.2 W
DC Output Current	20 mA

Stresses above those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.

Absolute Maximum Ratings are for system-design reference; parameters given are not 100% tested.

OPERATING RANGES

	(T _A) 0 to +70°C +4.5 V to +5.5 V
Military (M) Devices	(T _A *)55 to +125°C
	+4.5 V to +5.5 V

Operating ranges define those limits between which the functionality of the device is guaranteed.

*TA is defined as the "instant on" case temperature.

DC CHARACTERISTICS over operating ranges unless otherwise specified (for APL Products, Group A, Subgroups 1, 2, 3 are tested unless otherwise noted)

				Stan	dard	Low Power		Unit
Parameter Symbol	Parameter Description	Test	Min.	Max.	Min.	Max.		
ЮН	Output HIGH Current	V _{OH} = 2.4 V	V _{CC} = 4.5 V	-4		-4		mA
	Output LOW Current		T _A = 70°C	8 8		8		mA
lOL		V _{OL} = 0.4 V	T _A = 125°C	В		N/A		ПИ
V _{IH}	Input HIGH Voltage			2.0	6.0	2.0	6.0	٧
VIL	Input LOW Voltage			-0.5	0.8	-0.5	0.8	٧
1 X	Input Load Current	V _{SS} ≤ V ₁ ≤ V _{CC}		-10	10		10	μΑ
loz	Output Leakage Current	GND < Vo < Vcc Output Disabled T _A = -55 to+125°C		-50	50	-50	50	μΑ
Cı	Input Capacitance	Test Frequency = 1.0		5		5	ρF	
C _{I/O}	Input/Output Capacitance		T _A = 25°C, All Pins at 0 V, V _{CC} = 5 V				7	
loc	V _{CC} Operating	Max. V _{CC} , CS < V _{IL}	TA = 0 to+ 70°C		180		125	mA
·cc	Supply Current	Output Open	T _A = -55 to+125°C		180		N/A	
	Automatic CS Power	Max. V _{CC}	T _A = 0 to+70°C		30		20	mA
ISB	Down Current	(CS > VIH)	T _A = -55 to+125°C		30		N/A	III/
	Peak Power-On	Max. V _{CC} ,	T _A = 0 to+70°C		50		30	
l _{PO}	Current	(CS > V _{IH}) (Notes 3 & 12)	T _A = -55 to+125°C		50		N/A	mA
los	Output Short-Circuit	GND < VO < VCC	T _A = 0 to+70°C		±275		±275	mA
·US	Current	(Notes 11, 12)	T _A = -55 to+ 125°C		±350		±350	

- Notes: 1. Test conditions assume signal transition times of 10 ns or less, timing reference levels of 1.5 V, input pulse levels of 0 to 3.0 V and output loading of the specified IOL/IOH and 30 pF load capacitance. Output timing reference is 1.5 V.
 - 2. The internal write time of the memory is defined by the overlap of CS LOW and WE LOW. Both signals must be LOW to initiate a write and either signal can terminate a write by going HIGH. The data input setup and hold timing should be referenced to the rising edge of the signal that terminates the write.
 - 3. A pullup resistor to VCC on the CS input is required to keep the device deselected during VCC power up. Otherwise IPO will exceed values given (Am2148 only).
 - 4. The operating ambient temperature is defined as the "instant-ON" case temperature.
 - 5. Chip deselected greater than 55 ns prior to selection.
 - 6. Chip deselected less than 55 ns prior to selection.
 - 7. Transition is measured ±500 mV from steady state voltage with specified loading in Figure B. These parameters are sampled and not 100% tested.
 - 8. WE is HIGH for read cycle.

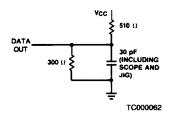
 - Device is continuously selected, CS = V_{IL}.
 Address valid prior to or coincident with CS transition LOW.
 - 11. For test purposes, not more than one output at a time should be shorted. Short circuit test duration should not exceed 30 seconds.
 - 12. This parameter is sampled and not 100% tested, but guaranteed by characterization.

SWITCHING CHARACTERISTICS over operating range unless otherwise specified (Note 1) (for APL Products, Group A, Subgroups 9, 10, 11 are tested unless otherwise noted)

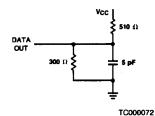
	B	r Parameter		Am214	18/9-35	Am2148/9-45 Am21L48/9-45		Am2148/9-55 Am21L48/9-55		Am2148/9-70 Am21L48/9-70		
No.	Parameter Symbol			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Unit
R	ead Cycle											
1	t _{RC}	Address Valid to Address Do Not Care Time (Read Cycle Time)		35		45		55		70		ns
2	taa	Address Valid to Data Out Valid De (Address Access Time)	elay		35		45		55		70	ns
3	t _{ACS1}	Chip Select LOW to Data Out	(Note 5)		35		45		55		70	ns
4	1ACS2	Valid (Am2148 only)	(Note 6)		45		55		65		80	
5	tacs	Chip Select LOW to Data Out Valid (Am2149 only)	i		15		20		25		30	ns
6		Chip Select LOW to	Am2148	10		10		10		10		ns
ь	†LZ	Data Out On (Notes 7 & 12)	Am2149	5		5		5		5		113
7	tHZ	Chip Select HIGH to Data Out Off (Notes 7 & 12)		0	20	0	20	0	20	0	20	ns
8	tон	Output hold after address change		5		5		5		5		ns
9	t _{PD}	Chip Select HIGH to Power Down Delay (Note 12)	Am2148		30		30		30		30	ns
10	tpU	Chip Select LOW to Power Up Delay (Note 12)	Am2148	0		0		0		0		ns
W	rite Cycle	***				_						
11	twc	Address Valid to Address Do Not Care (Write Cycle Time)		35		45		55		70		ns
12	t _{WP}	Write Enable LOW to Write Enable 2)	HIGH (Note	30		35		40		50		ns
13	twn	Write Enable HIGH to Address		5		5		5		5		ns
14	twz	Write Enable LOW to Output in High Z (Notes 7 & 12)		0	10	0	15	0	20	0	25	ns
15	tow	Data In Valid to Write Enable HIGH	1	20		20	1	20		25		ns
16	^t DH	Data Hold Time		0		0		0		0		ns
17	tas	Address Valid to Write Enable LOV		0		0		0		0		ns
18	tcw	Chip Select LOW to Write Enable (Note 2)	HIGH	30		40		50		65		ns
19	tow	Write Enable HIGH to Output in Lo (Notes 7 & 12)	w Z	0		0		0		0		ns
20	taw	Address Valid to End of Write		30		40		50		65	L	ns

Notes: See notes following DC Characteristics table.

SWITCHING TEST CIRCUITS

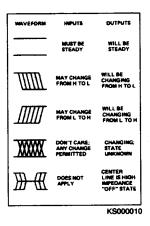


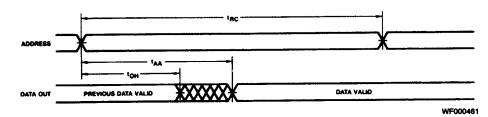
A. Output Load



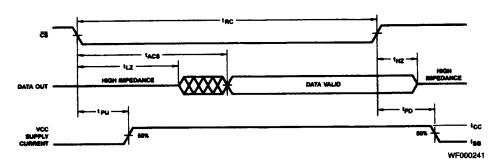
B. Output Load for tHz, tLz, tow, twz

SWITCHING WAVEFORMS KEY TO SWITCHING WAVEFORMS





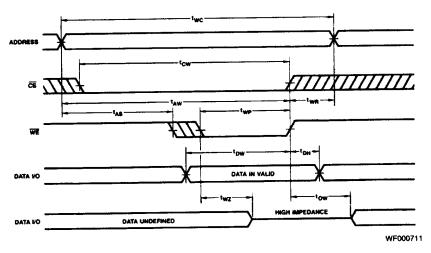
Read Cycle No. 1 (Notes 8, 9)



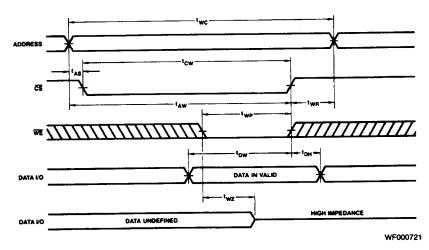
Read Cycle No. 2 (Notes 8, 10)

Notes: See notes following DC Characteristics table.

SWITCHING WAVEFORMS (Cont'd.)



Write Cycle No. 1 (WE Controlled)



Write Cycle No. 2 (CS Controlled)

Note: If $\overline{\text{CS}}$ goes HIGH simultaneously with $\overline{\text{WE}}$ HIGH, the output remains in a high-impedance state.

TYPICAL PERFORMANCE CURVES

